

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
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PROPERTY NUMBERS Total: 1															
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Application Number:	13320397
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CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	111463
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NAME OF SUBMITTER:	Stephen G. Adrian
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Total Attachments: 3

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FOR GOOD AND VALUABLE CONSIDERATION, the adequacy and receipt of which is hereby acknowledged by the undersigned inventor(s) (hereinafter ASSIGNOR) by

NATIONAL INSTITUTE FOR MATERIALS SCIENCE
2-1, Sengen 1-chome, Tsukuba-shi, Ibaraki 305-0047 Japan

Komatsu Seiki Kosakusho Co., Ltd.
942-2, Oaza Shigakuwabara, Suwa-shi, Nagano 392-0012 Japan

Tokushu Kinzoku Excel Co., Ltd.
4-25, Mejiro 1-chome, Toshima-ku, Tokyo 171-0031 Japan

(hereinafter ASSIGNEE), the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

“ORIFICE PLATE AND MANUFACTURING METHOD OF THE ORIFICE PLATE”

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

filed on **November 14, 2011** Application No. **13/320,397**

(Westerman, Hattori, Daniels & Adrian, LLP is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefore on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

<u>Shiro Torizuka</u>	<u>Shiro TORIZUKA</u>	<u>December 27, 2011</u>
(Signature)	(Type Name)	(Date)
<u>Eijiro Muramatsu</u>	<u>Eijiro MURAMATSU</u>	<u>December 27, 2011</u>
(Signature)	(Type Name)	(Date)
<u></u>	<u>Takafumi KOMATSU</u>	<u></u>
(Signature)	(Type Name)	(Date)
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(Signature)	(Type Name)	(Date)
<u></u>	<u>Mitsuyuki TANAKA</u>	<u></u>
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REEL: 027583 FRAME: 0340

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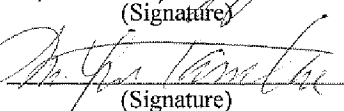
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